

UNAPPROVED MINUTES

IEEE 802.3 Ethernet Working Group

Plenary Opening Meeting

13-July 2026

<https://www.ieee802.org/3/minutes/jul26/index.html>

MONDAY, 13-JULY 2026

Minutes were taken by IEEE 802.3 Ethernet Working Group Recording Secretary Jon Lewis.

ADMINISTRATIVE MATTERS

Call to order

David Law, Chair of the IEEE 802.3 Ethernet Working Group, called the meeting to order at 10:15 EDT.

Welcome, introductions, and general announcements

Mr. Law held a minute of silence for Stuart Kerry.

Mr. Law noted that it would be too time consuming to have each individual introduce themselves, and that introductions would not be done at this hybrid meeting.

Mr. Law showed a list of officers of the IEEE 802.3 Working Group:

IEEE 802.3 Chair: David Law

IEEE 802.3 Vice-Chair: Adam Healey

IEEE 802.3 Secretary: Jon Lewis

IEEE 802.3 Executive Secretary: Chad Jones

IEEE 802.3 Treasurer: Valerie Maguire

IEEE 802.3 Task Force chairs

IEEE P802.3dg 100 Mb/s Long-Reach Single Pair Ethernet Task Force: George Zimmerman

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet: John D'Ambrosia

IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet: Natalie Wienckowski

IEEE P802.3dp Cabling Restrictions for Single Pair Power over Ethernet: Chad Jones

IEEE P802.3dq Pin-Optimized PHY Interface: Jason Potterf

IEEE Std 802.3-2022/Cor 2 (IEEE 802.3dr) Optical Automotive Ethernet TDFOM: Luisma Torres

IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs: Mabud Choudhury

IEEE P802.3dt Ethernet Metadata Services (Pro Tem): David Ofelt

IEEE 802.3 Study Group chairs

IEEE 802.3 400 Gb/s/Lane Signaling: Kent Lusted

IEEE 802.3 Fault-Managed Power (FMP) Ethernet Interoperability: Bob Voss

IEEE 802.3 Task Force vice-chairs

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet: Mark Nowell

IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet: Steve Gorshe

IEEE 802.3 Study Group vice-chair

IEEE 802.3 400 Gb/s/Lane Signaling: Mark Nowell

Working Group Decorum

Mr. Law introduced the Working Group decorum as described in the opening report. Please see https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=3 .

Mr. Law noted that there should be no recording without permission and that recording was disabled for this meeting in the teleconference tool.

Mr. Law noted that there was a change in the procedures for members of the press in the 2026 IEEE-SA Standards Board Operations manual. He then asked if anyone was attending from the press including those who would run a public blog on this meeting other than those limited to summarizing the meeting. There was no response.

Mr. Law introduced Mr. Jones who reminded the group of the procedure for participants including adding their affiliation in their screen name and noted other zoom guidelines for in-person and remote participants including the operation of the queues. Please see

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=6 .

Mr. Law informed the group that the July plenary meeting is subject to a registration fee and that there are penalties for non-payment of registration fees.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=8 .

Paul Nikolich, previous LMSC Chair, requested time for Fred Schindler (affiliated with Self) to provide a short introduction to the work of the IEEE Innovation Committee. Working Group members were encouraged to bring proposals to the IEEE Innovation Committee regarding IEEE 802.3 activities.

Review and approval of agenda

Mr. Law noted that a soft copy of the draft agenda had been posted to the minutes section for this meeting.

Mr. Law asked if there were any modifications to the draft agenda. Mr. Law noted that there are no LMSC officer's elections and that should be removed from the posted agenda.

MOTION #1

Approve the agenda with the LMSC officer elections removed.

M: J. D'Ambrosia

S: K. Lusted

Procedural (> 50%)

Motion Passed by unanimous consent 13-July 2026, 10:31 a.m. EDT

MOTION #2

Approve the January 2026 and March 2026 plenary minutes and the May 2026 interim minutes as posted.

M: K. Lusted

S: B. Kochuparambil

Procedural (> 50%)

Motion Passed by unanimous consent 13-July 2026, 10:33 a.m. EDT

Call for patents

Please see:

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=11

Mr. Law showed the IEEE patent policy slides and asked if anyone has not seen the patent policy before, no one responded.

Mr. Law asked if anyone was aware of any patent claims potentially essential to the proposed standards under development by the IEEE 802.3 Working Group. There was no response.

Mr. Law asked that Mr. Lewis record that:

The patent policy, per the latest PatCom slide set, was shown

There was no response to the call for potentially essential patent claims

Anyone wishing to submit a letter of assurance can do so at any time by contacting Mr. Law or the PatCom administrator

Mr. Law reminded the group of inappropriate topics that should not be discussed. These included territory, market share, price, ongoing litigation, threatened litigation, etc.

Mr. Law asked if anyone had not seen the copyright slides previously, no one responded, and he proceeded to review the IEEE SA copyright slides.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=16

Mr. Law advised participants that:

- IEEE SA's copyright policy is described in Clause 7 of the IEEE SA Standards Board Bylaws and Clause 6.1 of the IEEE SA Standards Board Operations Manual;
- Prior to presentation or submission, you shall notify the Working Group Chair of previously Published material and should assist the Chair in obtaining copyright permission acceptable to IEEE SA. For material that is not previously Published, IEEE is automatically granted a license to use any material that is presented or submitted.

Mr. Law asked if anyone had not seen the participation slides previously, no one responded. He then reviewed the IEEE SA participation slides and highlighted the two new slides (Pages 22 and 23).

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=19

Mr. Law advised that participants in IEEE SA Activities are bound to the following:

- No participant may exercise “authority, leadership, or influence by reason of superior leverage, strength, or representation to the exclusion of fair and equitable consideration of other viewpoints” or “to hinder the progress of the standards development activity”
- Participants in attendance at IEEE SA Standards development activity meetings shall adhere to appropriate meeting decorum, and IEEE SA meeting rules. Recording is not permitted.
- Participants intending to report publicly on this meeting (e.g., via news outlets, social media, or online forums) shall inform the Chair of their attendance and the Chair shall announce their presence and their intent to report publicly.
- Participants shall comply with IEEE SA Standards Board Operations Manual 5.1.4 Standards promotion and social media communication requirements.
- Participants can contact the IEEE concerning alleged violations of IEEE's Code of Conduct, Code of Ethics, or other policies and rules using the information given.

General Working Group business

Mr. Law explained the membership requirements (gaining):

- Attendance in at least 75% of meeting slots¹ at two of the last four plenary sessions
 - Attendance in at least 75% of meeting slots at a recent IEEE 802.3 Ethernet Working Group or Task Group Interim Session may be substituted for one of the two Plenary Sessions
- Attendance in at least 75% of the meeting slot's duration is required for that attendance to count towards gaining or maintaining voting membership
- Maintain valid contact information
- Provide declaration of affiliation
- Request to become member during potential voter agenda item at an IEEE 802.3 Ethernet Working Group opening or closing **plenary** meeting

Membership requirements (retaining)

- Continue to meet above attendance, contact, and affiliation requirements
- Participate in two out of the last three Working Group Letter Ballot Series

¹ There are four IMAT meeting slots during the day during plenary and credited interim sessions

Mr. Lewis reviewed the membership and attendance tool procedures.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=27

Please see <http://ieee802.org/3/rules/index.html> for complete information.

Mr. Law asked the group to take a moment and sign in to IMAT.

Mr. Law reminded the group of the tutorial session this evening on “IEEE SA Liaisons with Organizations External to IEEE” and explained “specially maintained” voters.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=30

Review of voting membership

Please https://www.ieee802.org/3/minutes/jul26/0726_voters.pdf

Review of voters in peril

Please https://www.ieee802.org/3/minutes/jul26/0726_peril.pdf

Review of Potential voters

Please see https://www.ieee802.org/3/minutes/jul26/0726_potential.pdf

The following participants requested voting rights during the opening plenary:

Abraham, Shiju	Hameed, Anil	Parthasarathy, Vasu
Aripirala, Ravi	Haydt, Mary Sue	Peng, Bc
Budweiser, Karl	Heck, Howard	Pfeifle, Joerg
Chang, Frank	Hiroaki, Kukita	Pinto, Anthony
Chen, Chan	Hon, Kam Yan	Ransford, Michael
Chen, Lihao	Huang, Qinhui	Rock, Jason
Chen, Yuanjie	Joseph, Gloria	Rysin, Alexander
Chidambaram, Valliaappan	Levy, Nir	Sekel, Steve
Cole, Christopher R.	Lu, Chao	Tanz, Simon
Donahue, Curtis	Mammenga, Kevin	Thomas, Rajan
Edele, Jonas	Matuz, Balazs	Tian, Yuchi
Elangovan, Vivekanandh	Murty, Ramana	Umar, Ashraf
Enoki, Naomichi	Oishi, Eiichiro	Vanderlaan, Paul
Gareau, Sebastien	Osorio, Luz	Voss, Robert
Gore, Brandon	Park, Pusik	Wang, Xiaofeng

Val Maguire presented the Working Group treasury report. Please see

https://www.ieee802.org/3/minutes/jul26/0726_treasury.pdf

Mr. Lewis displayed a list of the voters who requested voting rights in the opening plenary. Mr. Law asked if anyone who had requested voting rights, but was not shown correctly to speak up. There was no response.

Mr. Law showed the IEEE 802 LMSC report and meeting schedule. Please see

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=34

Mr. Law reminded the group to download the e-media if any participant didn't during the March meeting.

Mr. Law showed the other IEEE 802 LMSC PARs under consideration at the plenary session.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_opening_plenary.pdf#page=37

Mr. Lusted reported that there was a meeting held to review the other LMSC PARs and he would be submitting the comments decided in the meeting which were posted on behalf of IEEE 802.3 unless there were other comments, none responded.

LIAISONS

External Liaison letters (old)

EA: 'The AI Future: Ethernet' TEF and liaison officer [liaison letter](#), TEF [call for presentations](#)

ITU-T SG15: Technical report of use cases and requirements beyond 10Gbps [liaison letter](#)

OIF: CEI-224G-LR-PAM4 and CEI-224G-MR-PAM4 [liaison letter](#) and attachment [1](#) and [2](#)

External Liaison letters (new)

Broadband Forum: Recently published Broadband Forum Work Items [liaison letter](#)

Ethernet Alliance: Ethernet Alliance "Vision 2027" [liaison letter](#)

IEC SC 86B: Intent to Contribute to E4AI Workshop [liaison letter](#)

ITU-T SG15: ITU-T ANT and HNT Overviews and Work Plans [liaison letter](#)

ITU-T SG15: Latest updates of ANT and HNT Standards Overviews and Work Plans [liaison letter](#)

ITU-T SG15: OTNT Standardization Work Plan Issue 37 [liaison letter](#) and [attachment](#)

ITU-T SG15: New work item GSTR-HCF "Hollow core fibre technologies and systems" [liaison letter](#)

ITU-T SG15: ITU-T G.8020.3 Editions 3.0 and 4.0 [liaison letter](#) and [attachment](#)

ITU-T SG15: Draft revised Recommendations ITU-T G.709.1 and ITU-T G.709.6 [liaison letter](#)

ITU-T SG15: Draft new Recommendation ITU-T G.709.7 [liaison letter](#) and [attachment](#)

Mr. D'Ambrosia noted that no response is necessary.

ITU-T SG15: IM/DM modelling coordination [liaison letter](#)

ITU-T SG15: Study of in-vehicle optical network based on FIP technologies [liaison letter](#)

TIA TR42: Intent to Contribute to E4AI Workshop [liaison letter](#)

External Liaison reports

IEC TC 86 Fibre optics

<https://www.ieee802.org/3/minutes/jul26/incoming/IEC%20SC%2086B%20Response%20to%20IEEE%20802.3.pdf>

INCITS T11 INCITS T11 Fibre Channel [April 2026](#) and [June 2026](#) meeting report

TIA TR-42 Telecommunications Cabling Systems

https://www.ieee802.org/3/minutes/jul26/20260712_TIA_Liaison_Report_802.3.pdf

Opening reports:

IEEE 802.3 rules report – Adam Healey

https://www.ieee802.org/3/minutes/jul26/0726_rules_open_report.pdf

IEEE P802.3dg 100 Mb/s Long-Reach Single Pair Ethernet Task Force - George Zimmerman

https://www.ieee802.org/3/minutes/jul26/802d3dg_open_report_Jul2026.pdf

Mr. Law asked if there was anyone that still hadn't signed into IMAT and that he would not be adjusting the attendance after the meeting, none responded.

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet Task Force - John D'Ambrosia

https://www.ieee802.org/3/minutes/jul26/2607_3dj_open_report.pdf

IEEE P802.3dk Greater than 50 Gb/s Bidirectional Optical Access PHYs Task Force -Yuanqiu Luo

https://www.ieee802.org/3/minutes/jul26/802d3dk_Task_Force_open_report_2026JulyPlenary.pdf

IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet Task Force – Natalie Wienckowski

https://www.ieee802.org/3/minutes/jul26/802d3dm_TF_open_report.pdf

IEEE P802.3dp Cabling Restrictions for Single Pair Power over Ethernet Task Force – Chad Jones

https://www.ieee802.org/3/minutes/jul26/802d3dp_task_force_open_report_0726.pdf

IEEE P802.3dq Pin-Optimized PHY Interface Task Force Report – Jason Potterf

https://www.ieee802.org/3/minutes/jul26/POPI_Plenary_Opening_Report_2026-07-13.pdf

IEEE P802.3-2022/Cor 2 (IEEE 802.3dr) Optical Automotive Ethernet TDFOM – Luisma Torres

https://www.ieee802.org/3/minutes/jul26/802d3dr_task_force_open_report_01_0726.pdf

IEEE P802.3ds 200 Gb/s per wavelength Multimode Fibre (MMF) optical PHYs Task Force opening report – Mabud Choudhury

https://www.ieee802.org/3/minutes/jul26/3ds_task_force_open_report_2607.pdf

IEEE P802.3dt Ethernet Metadata Services Task Force opening report – David Ofelt

https://www.ieee802.org/3/minutes/jul26/802d3dt_task_force_opening_report_20260712.pdf

IEEE 802.3 400 Gbps per lane Study Group opening report – Kent Lusted

https://www.ieee802.org/3/minutes/jul26/2607_400GL_plenary_opening_report_v1_template.pdf

IEEE 802.3 FMP Ethernet Interoperability Study Group opening report – Bob Voss

https://www.ieee802.org/3/minutes/jul26/802d3_EFMP_SG_opening_report_20260713.pdf

IEEE 802.3 Power Delivery Coordinating Committee Ad Hoc - Chad Jones

https://www.ieee802.org/3/minutes/jul26/PDCC_adhoc_open_report_0726.pdf

IEEE 802.3 New Ethernet Applications Ad Hoc – Jon Lewis / John D'Ambrosia

https://www.ieee802.org/3/minutes/jul26/0726_NEA_open_report.pdf

IEEE 802.3 Channel Operating margin (COM) opening report – Howard Heck

https://www.ieee802.org/3/minutes/jul26/0726_COM_ad_hoc_opening_report.pdf

IEEE 802.3 YANG Ad Hoc – Peter Jones

https://www.ieee802.org/3/minutes/jul26/802d3_yang_opening_report_071326.pdf

PLCA Multidrop Latency, Jitter, and Scalability Enhancements CFI opening report – Yong Kim

https://www.ieee802.org/3/minutes/jul26/IEEE802-3%20CFI%20PLCA%20Enhancement%20Opening%20Report_0726.pdf

Room assignments and Subgroup schedules. Mr. Jones shared how to find the meeting room locations for the week and gave the location on the website for the online schedule.

Mr. Lewis noted that the P802.3dj AM1 session this morning would not count towards meeting attendance credit and was a co-located interim and not part of the plenary meeting series.

Mr. Law announced that as the agenda had been exhausted the meeting was adjourned.

Mr. Law adjourned the meeting at 12:18 EDT.

Adjourned.

UNAPPROVED MINUTES

IEEE 802.3 Ethernet Working Group

Plenary Closing Meeting

16-July 2026

<https://www.ieee802.org/3/minutes/jul26/index.html>

THURSDAY, 16-JULY 2026

Minutes were taken by IEEE 802.3 Ethernet Working Group Recording Secretary Jon Lewis.

ADMINISTRATIVE MATTERS

Call to order

David Law, Chair of the IEEE 802.3 Ethernet Working Group, called the meeting to order at 13:15 EDT.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf

Welcome, introductions, and general announcements

Mr. Law noted that it would be too time consuming to have each individual introduce themselves, that introductions would not be done at this hybrid meeting.

Mr. Law showed a list of officers of the IEEE 802.3 Working Group:

IEEE 802.3 Chair: David Law

IEEE 802.3 Vice-Chair: Adam Healey

IEEE 802.3 Secretary: Jon Lewis

IEEE 802.3 Executive Secretary: Chad Jones

IEEE 802.3 Treasurer: Valerie Maguire

IEEE 802.3 Task Force chairs

IEEE P802.3dg 100 Mb/s Long-Reach Single Pair Ethernet Task Force: George Zimmerman

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet: John D'Ambrosia

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IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs: Mabud Choudhury

IEEE P802.3dt Ethernet Metadata Services (Pro Tem): David Ofelt

IEEE 802.3 Study Group chairs

IEEE 802.3 400 Gb/s/Lane Signaling: Kent Lusted

IEEE 802.3 Fault-Managed Power (FMP) Ethernet Interoperability: Bob Voss

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IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet: Mark Nowell

IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet: Steve Gorshe

IEEE 802.3 Study Group vice-chair

IEEE 802.3 400 Gb/s/Lane Signaling: Mark Nowell

Working Group Decorum

Mr. Law introduced the Working Group decorum as described in the closing report. Please see https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=3.

Mr. Law noted that there should be no recording without permission and that recording was disabled for this meeting in the teleconference tool.

Mr. Law noted that there was a change in the procedures for members of the press in the 2026 IEEE-SA Standards Board Operations manual. He then asked if anyone was attending from the press including those who would run a public blog on this meeting other than those limited to summarizing the meeting. There was no response.

Mr. Law introduced the procedure for participants to provide their affiliation in their screen name and noted other zoom guidelines for in-person and remote participants including the operation of the queues. Mr. Jones notified the group that if this isn't complied with you will be removed from the meeting.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=6.

Mr. Law informed the group that the July plenary meeting is subject to a registration fee and that there are penalties for non-payment of registration fees.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=8 .

Review and approval of agenda

Mr. Law noted that a soft copy of the draft agenda had been posted to the minutes section for this meeting.

Mr. Law asked if there were any additions to the draft agenda. There was no response.

MOTION #1

Approve the agenda removing the NEA Liaison.

M: Kent Lusted

S: Tom Palkert

Procedural (> 50%)

Motion Passed by unanimous consent 16-July 2026, 13:25 EDT

Call for patents

Please see

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=11

Mr. Law showed the IEEE patent policy slides.

Mr. Law asked if anyone was aware of any patent claims potentially essential to the proposed standards under development by the IEEE 802.3 Working Group. There was no response.

Mr. Law asked that Mr. Lewis record that:

The patent policy, per the latest PatCom slide set, was shown

There was no response to the call for potentially essential patent claims

Anyone wishing to submit a letter of assurance can do so at any time by contacting Mr. Law or the PatCom administrator

Mr. Law reminded the group of inappropriate topics that should not be discussed. These included territory, market share, price, ongoing litigation, threatened litigation, etc.

Mr. Law reviewed the IEEE SA copyright slides.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=16

Mr. Law advised participants that:

- IEEE SA's copyright policy is described in Clause 7 of the IEEE SA Standards Board Bylaws and Clause 6.1 of the IEEE SA Standards Board Operations Manual;
- Prior to presentation or submission, you shall notify the Working Group Chair of previously Published material and should assist the Chair in obtaining copyright permission acceptable to IEEE SA. For material that is not previously Published, IEEE is automatically granted a license to use any material that is presented or submitted.

Mr. Law reviewed the IEEE SA participation slides.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=19

Mr. Law advised participants that in IEEE SA Activities are bound to the following:

- No participant may exercise “authority, leadership, or influence by reason of superior leverage, strength, or representation to the exclusion of fair and equitable consideration of other viewpoints” or “to hinder the progress of the standards development activity”
- Participants in attendance at IEEE SA Standards development activity meetings shall adhere to appropriate meeting decorum, and IEEE SA meeting rules. Recording is not permitted.
- Participants intending to report publicly on this meeting (e.g., via news outlets, social media, or online forums) shall inform the Chair of their attendance and the Chair shall announce their presence and their intent to report publicly.
- Participants shall comply with IEEE SA Standards Board Operations Manual 5.1.4 Standards promotion and social media communication requirements.
- Participants can contact the IEEE concerning alleged violations of IEEE's Code of Conduct, Code of Ethics, or other policies and rules using the information given.

General Working Group business

Attendance procedures, tool, and e-mail list maintenance

Mr. Law explained the membership requirements (gaining):

- Attendance in at least 75% of meeting slots² at 2 of last 4 plenary sessions
 - Attendance in at least 75% of meeting slots at a recent IEEE 802.3 Ethernet Working Group or Task Group Interim Session may be substituted for one of the two plenary sessions
- Attendance in at least 75% of meeting slot's duration is required for that attendance to count towards gaining or maintaining voting membership
- Maintain valid contact information
- Provide declaration of affiliation
- Request to become member during potential voter agenda item at an IEEE 802.3 Ethernet Working Group opening or closing **plenary** meeting

Membership requirements (retaining)

- Continue to meet the above attendance, contact, and affiliation requirements
- Participate in two out of the last three Working Group Letter Ballot Series

Mr. Law noted the this plenary meeting requires a paid registration fee and that attending any of the sessions without paying the fee had adverse consequences.

Membership and attendance recording

Mr. Lewis reviewed the membership and attendance tool procedures.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=27

Please see <http://ieee802.org/3/rules/index.html> for complete information.

Review of voting membership

Please https://www.ieee802.org/3/minutes/jul26/0726_voters.pdf

Review of voters in peril

Please https://www.ieee802.org/3/minutes/jul26/0726_peril.pdf

Review of Potential voters

Please see https://www.ieee802.org/3/minutes/jul26/0726_potential.pdf

The following participants requested voting rights during the closing plenary:

Cole, Christopher R.

² There are four IMAT meeting slots during the day during plenary and credited interim sessions

IEEE 802 LAN/MAN Standards Committee items

Mr. Law showed the IEEE 802 LMSC report.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=30

Other IEEE 802 PARs

Mr. Lusted noted that comments submitted to the other groups were incorporated or overtaken by events and that there was nothing of concern.

Liaisons

Mr. Law showed the IEEE SA Operations Manual Clause 7.

https://www.ieee802.org/3/minutes/jul26/0726_802_3_closing_plenary.pdf#page=33

Motion on slide 35

MOTION #2

IEEE 802.3 Ethernet Working Group Standards Committee External Liaison Coordinators (aka liaison officers) are directed to (a) share project status of projects of interest to their liaison organisation, and the reverse and (b) share discussion of items of interest to their liaison organisation, and the reverse

IEEE 802.3 liaison officers are authorised by the IEEE 802.3 Ethernet Working Group to share the public URL of any IEEE 802.3 information posted on the IEEE 802.3 website with their liaison organisation

M: John D'Ambrosia

S: Kent Lusted

Procedural (> 50%)

Motion Passed without objection 16-July 2026, 13:53 EDT

External Liaison letters (old)

EA: 'The AI Future: Ethernet' TEF and liaison officer [liaison letter](#), TEF [call for presentations](#)

No Response necessary

ITU-T SG15: Technical report of use cases and requirements beyond 10Gbps [liaison letter](#)

NEA to respond out of the September 2026 interim meeting.

OIF: CEI-224G-LR-PAM4 and CEI-224G-MR-PAM4 [liaison letter](#) and attachment [1](#) and [2](#)

No Response necessary

External Liaison letters (new)

ITU-T SG15: ITU-T ANT and HNT Overviews and Work Plans [liaison letter](#)

ITU-T SG15: Latest updates of ANT and HNT Standards Overviews and Work Plans [liaison letter](#)

ITU-T SG15: OTNT Standardization Work Plan Issue 37 [liaison letter](#) and [attachment](#)

Prior 3 will be replied out of the January interim Working Group meeting.

ITU-T SG15: New work item GSTR-HCF "Hollow core fibre technologies and systems" [liaison letter](#)

ITU-T SG15: ITU-T G.8020.3 Editions 3.0 and 4.0 [liaison letter](#) and [attachment](#)

Reply out of the January interim Working Group meeting.

ITU-T SG15: Draft revised Recommendations ITU-T G.709.1 and ITU-T G.709.6 [liaison letter](#)

ITU-T SG15: Draft new Recommendation ITU-T G.709.7 [liaison letter](#) and [attachment](#)

Mr. D'Ambrosia noted that no response is necessary.

ITU-T SG15: Study of in-vehicle optical network based on FIP technologies [liaison letter](#)

Mr. Law reminded the group to sign into IMAT.

Future Meetings Report – Chad Jones

https://www.ieee802.org/3/minutes/jul26/0726_802d3_future_meetings.pdf

Future Meetings Straw Poll:

How many people would like to come back to this venue?

Yes: 50 No: 21

Did you go to the social?

Yes: 77 No: 7

If you attended the social, did you like the social?

Yes: 71 No: 2

IEEE 802.3 September 2027 Offer to Host – Xiang He

<https://www.ieee802.org/3/minutes/jul26/Huawei%20Offer%20to%20host%20Sep%20'27%20Belgium.pdf>

MOTION #3

Move that IEEE 802.3 accept the Huawei offer to host the
September 2027 interim as detailed in:

<https://www.ieee802.org/3/minutes/jul26/Huawei%20Offer%20to%20host%20Sep%20'27%20Belgium.pdf>

M: Chad Jones S: Bob Voss

By Rule $\geq 75\%$

Motion Passed by unanimous consent 16-July 2026, 14:12 EDT

Closing reports and actions:

IEEE 802.3 Rules - Adam Healey

https://www.ieee802.org/3/minutes/jul26/0726_rules_close_report.pdf

MOTION #4

Approve the proposed IEEE 802.3 rules change 1-03/26 without a 30-day WG letter
ballot.

M: J. D'Ambrosia S: Kent Lusted

By Rule $\geq 75\%$

Motion Passed by unanimous consent 16-July 2026, 14:17 EDT

IEEE 802.3 Maintenance – Adam Healey

https://www.ieee802.org/3/minutes/jul26/0726_maint_close_report.pdf

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet Task Force closing report – John D’Ambrosia

https://www.ieee802.org/3/minutes/jul26/2607_3dj_closed_report.pdf

MOTION #5

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dj PAR extension, in <https://mentor.ieee.org/802-lmsc/dcn/26/lmsc-26-0172-00-LMSC-ieee-p802-3dj-par-extension-request.pdf>

M: John D’Ambrosia

S: Mark Nowell

Technical ($\geq 75\%$)

Y: 118 N: 0 A: 7

Motion Passed 16-July 2026, 14:45 EDT

IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet – Natalie Wienckowski

https://www.ieee802.org/3/minutes/jul26/802d3dm_TF_close_report.pdf

MOTION #6

Move that the IEEE 802.3 Working Group approve:
https://www.ieee802.org/3/minutes/jul26/outgoing/draft_802d33-to-SG15-Q3-IVN_Redacted.pdf, with editorial license granted to the Chair (or his appointed agent) as a liaison communication from the IEEE 802.3 to ITU-T

M: N. Wienckowski on behalf of the Task Force

Y: 101 N: 0 A: 8

Motion Passed 16-July 2026, 14:52 EDT

IEEE P802.3dq Pin-Optimized PHY Interface Task Force – Jason Potterf

https://www.ieee802.org/3/minutes/jul26/POPI_Plenary_Closing_Report_2026-07-16_v01.pdf

MOTION #7

Move that the IEEE 802.3 Working Group approve the IEEE Pin-Optimized PHY Interface Task Force objectives, as per POPI_Plenary_Closing_Report_2026-07-16_v01.pdf objectives

M: Jason Potterf S: Peter Jones

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 14:59 EDT

IEEE Std 802.3-2022/Cor 2 (IEEE 802.3dr) – Luisma Torres

https://www.ieee802.org/3/minutes/jul26/802d3dr_task_force_closing_report_01_0726.pdf

MOTION #8

Move to request conditional approval to progress the IEEE 802.3dr draft to RevCom once the IEEE SA ballot process has been successfully completed

M: Luisma Torres S: Jason Potterf

Technical ($\geq 75\%$)

Y: 94 N: 0 A: 10

Motion Passed 16-July 2026, 15:04 EDT

IEEE P802.3ds 200 Gb/s per Wavelength MMF PHYs Task Force – Mabud Choudhury

https://www.ieee802.org/3/minutes/jul26/3ds_task_force_closing_report_2607.pdf

IEEE P802.3dt Ethernet Metadata Services Task Force – David Ofelt

https://www.ieee802.org/3/minutes/jul26/802d3dt_task_force_closing_report_2607.pdf

MOTION #9

Move to adopt the changes to the objectives shown in

https://www.ieee802.org/3/dt/projdoc/objectives_ems_260512.pdf

M: David Ofelt on behalf of the Task Force

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 15:11 EDT

The Working Group took a short break at 15:11 EDT

The Working Group meeting resumed at 15:33 EDT

IEEE 802.3 400 Gbps per lane PHYs and Interfaces CFI – Kent Lusted

https://www.ieee802.org/3/minutes/jul26/2603_400GL_plenary_closing_report.pdf

MOTION #10

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dv 400 Gb/s/lane Signaling PAR, in <https://mentor.ieee.org/802-lmsc/dcn/26/lmsc-26-0120-01-LMSC-ieee-p802-3dv-draft-par.pdf>

M: Kent Lusted S: Mark Nowell

Technical ($\geq 75\%$)

Y: 85 N: 0 A: 5

Motion Passed 16-July 2026, 15:41 EDT

MOTION #11

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dv 400 Gb/s/lane Signaling CSD, in <https://mentor.ieee.org/802-lmsc/dcn/26/lmsc-26-0121-01-LMSC-ieee-p802-3dv-draft-csd.pdf>

M: Kent Lusted S: Beth Kochuparambil

Technical ($\geq 75\%$)

Y: 84 N: 0 A: 5

Motion Passed 16-July 2026, 15:43 EDT

MOTION #12

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dv 400 Gb/s/lane Signaling Objectives, in https://www.ieee802.org/3/400GPL/public/project_docs/400GPL_Objectives_260610.pdf

M: Kent Lusted S: Matt Brown

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 15:46 EDT

MOTION #13

Move that the IEEE 802.3 Working Group request 1st rechartering of IEEE 802.3 400 Gb/s/lane Signaling Study Group

M: Kent Lusted S: Mark Nowell

By rule (> 50%)

Y: 95 N: 0 A: 3

Motion Passed 16-July 2026, 15:48 EDT

IEEE 802.3 Fault Managed Power Ethernet Powering Techniques CFI – Bob Voss

https://www.ieee802.org/3/minutes/jul26/EFMP_Plenary_Closing_Report_20260716.pdf

MOTION #14

Move that the IEEE 802.3 Working Group request the re-chartering of the EFMP Study Group.

M: Bob Voss on behalf of the Study Group

By rule (> 50%)

Y: 92 N: 0 A: 4

Motion Passed 16-July 2026, 15:56 EDT

MOTION #15

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dw EFMP Basic Objectives, per slide 9 of

https://www.ieee802.org/3/EFMP/public/260715/EFMP_Plenary_Closing_Report_20260716.pdf

M: Bob Voss S: Jason Potterf

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 15:58 EDT

MOTION #16

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dw EFMP CSD “Managed Objects”, “Coexistence”, “Broad Market Potential”, “Compatibility”, “Distinct Identity”, “Technical Feasibility”, and “Economic Feasibility” responses, as per https://www.ieee802.org/3/EFMP/public/260715/CSD_EFMP_20260715.pdf.

M: Bob Voss S: George Zimmerman

Technical ($\geq 75\%$)

Y: 77 N: 0 A: 9

Motion Passed 16-July 2026, 16:03 EDT

MOTION #17

Move that the IEEE 802.3 Working Group approve the IEEE P802.3dw EFMP PAR, in https://www.ieee802.org/3/EFMP/public/260715/P802.3dw_PAR_150726.pdf

M: Bob Voss S: Chad Jones

Technical ($\geq 75\%$)

Y: 81 N: 0 A: 10

Motion Passed 16-July 2026, 16:10 EDT

Mr. Law announced that should the P802.3dv PAR be approved by SASB, he intends to appoint Kent Lusted as Chair.

Mr. Law announced that should the P802.3dw PAR be approved by SASB, he intends to appoint Bob Voss as Chair.

IEEE 802.3 New Ethernet Applications ad hoc E4AI Assessment – John D’Ambrosia

https://www.ieee802.org/3/minutes/jul26/0726_NEA_close_report.pdf

MOTION #18

Move that the IEEE 802.3 Working Group approve

https://www.ieee802.org/3/minutes/jul26/IC15-005%20New%20Ethernet%20Applications_Status%20Report%20Sept%202026-closing.pdf

As the 2026 status report from the IEEE 802.3 NEA Ad Hoc.

M: John D’Ambrosia

S: Kent Lusted

Technical ($\geq 75\%$)

Y: 84 N: 0 A: 2

Motion Passed 16-July 2026, 16:20 EDT

IEEE 802.3 COM Ad Hoc – Howard Heck

https://www.ieee802.org/3/minutes/jul26/0726_COM_ad_hoc_closing_report.pdf

MOTION #19

Move to generate COM v4.16 from COM 4.15 and the dispositions per 0726_COM_ad_hoc_plenary_close_report, slide 3.

M: Kent Lusted

S: Hansel D’Silva

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 16:26 EDT

MOTION #20

Move that the IEEE 802.3 Working Group approve the initial release of YANG modules by the 802.3 YANG Open Source project. The release will comprise the models showing “Covered by CLA = Yes” in slide 4 of this presentation.

M: Peter Jones

S: Ulf Parkholm

Technical ($\geq 75\%$)

Motion Passed by unanimous consent 16-July 2026, 16:31 EDT

MOTION #21

Move that the IEEE 802.3 Working Group request the formation of a Study Group to develop a Project Authorization Request (PAR) and Criteria for Standards Development (CSD) for Physical Layer Collision Avoidance (PLCA) Multidrop Latency, Jitter, and Scalability Enhancements.

M: Markus Jochim

S: Tim Baggett

By rule ($> 50\%$)

Y: 72 N: 3 A: 21

Motion Passed 16-July 2026, 16:45 EDT

Mr. Law announced that should the Study Group be approved, he intends to appoint Yong Kim as Chair of the Study Group.

Awards:

IEEE Std 802.3dg-2026 awards – George Zimmerman

Mr. Law asked if there was any additional general business:

Chad Jones announced that the hotel would be charging the room 15 days prior to arrival in Lisbon for the September 2026 interim meeting series.

Mr. Law announced that as the agenda had been exhausted the meeting was adjourned.

Mr. Law adjourned the meeting at 17:12 EDT.

Adjourned.

Appendix A: Attendance list for Working Group Opening plenary from IMAT

Name	Employer	Affiliation	Open	Close
Abraham, Shiju		Acsia Technologies	X	X
Abramczyk, Jaroslaw		Coherent	X	
Ahuja, Ramanjit	ON Semiconductor	ON Semiconductor	X	X
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation	X	X
Alloin, Laurent		Ciena Corporation	X	X
Alwishah, Abbas	Molex Incorporated	Molex Incorporated		X
Anantha Murthy, Vijay	Keysight Technologies Inc	Keysight Technologies Inc		X
Baek, Brian		Apple Inc.	X	
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.	X	X
Bar-Niv, Amir	Aquantia Corp	Marvell	X	
Bar-Niv, Amir	Aquantia Corp	Infineon Technologies		X
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	X	
Benyamin, Saied	Ethernovia	Ethernovia	X	X
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.	X	X
Boyer, Rich	Aptiv - Signal and Power Solutions	Aptiv Signal and Power Solutions	X	X
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	X	X
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	X	X
Brown, Matthew	Alphawave Semi	Qualcomm	X	X
Bruckman, Leon	NVIDIA	NVIDIA	X	X
Budweiser, Karl		BMW AG; BMW Group	X	X
Calvin, John	Keysight Technologies	Keysight Technologies	X	X
Castro, Jose	Panduit	Panduit Corp.	X	X
Chang, Jae-yong	Keysight Technologies Inc	Keysight Technologies Inc	X	X
Chang, Yongmao	Inphi Corporation	Source Photonics		X
Chen, Chan	Self Employed	Independent/AOI	X	X
Chen, Lihao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	
cheng, xiaoyue		Infineon Technologies	X	X
Chidambaram, Valliaappan		Acsia Technologies	X	X
Chimento, Nicholas		Analog Devices Inc.	X	X
Chini, Ahmad	Broadcom Corporation	Broadcom Corporation	X	X
Choudhury, Golam	Genuine Optics	Genuine Optics	X	X
Chow, Kai Soon		Apple Inc.	X	
Chughtai, Muhammad Saad		Tektronix, Inc.		X
Cole, Christopher R	Finisar Corporation	Coherent Corp.	X	X
Cordaro, Joseph	Infineon Technologies	Infineon Technologies	X	X

Name	Employer	Affiliation	Open	Close
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei	X	X
Dai, Shaoan		Infineon Technologies	X	X
Dar, Marva	TE Connectivity	TE Connectivity	X	X
Dawe, Piers J G	NVIDIA	Nvidia	X	X
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc	X	X
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.	X	X
Donahue, Curtis	Rohde & Schwarz	Rohde & Schwarz	X	X
Dsilva, Hansel		Amphenol Corporation	X	X
Dudek, Michael	Marvell	Marvell	X	X
Edele, Jonas		BMW AG; BMW Group	X	
Estes, David	Spirent Communications	VIAVI Solutions	X	X
Estrakh, Daniel	Valens Semiconductor	Valens Semiconductor	X	X
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	X	
Fuller, Paul		Infineon Technologies	X	X
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.	X	X
Gareau, Sebastien		Ciena Corporation	X	X
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.	X	X
Glanzner, Martin	SEI ANTech-Europe GmbH	SEI Automotive Europe GmbH		X
Goel, Sachin	Aviva Links Inc	NXP	X	X
Gorshe, Steven Scott	Microchip Technology, Inc.	Microchip Technology, Inc.	X	X
Goto, Hideki	Toyota Motor Corporation	Toyota Motor Corporation	X	X
Graber, Steffen	Pepperl+Fuchs SE	Pepperl+Fuchs SE		X
Gubow, Martin	Keysight Technologies	Keysight Technologies	X	X
Hameed, Anil		Acsia Technologies	X	
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems	X	X
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)	X	
Hand, Steven		Nokia	X	X
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.	X	
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Healey, Adam	Broadcom Inc.	Broadcom Inc.	X	X
Heck, Howard	TE Connectivity	TE Connectivity	X	X
Helely, Oren		Marvell Semiconductor, Inc.	X	
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics	X	X
Hogenmueller, Thomas	Robert Bosch GmbH	Robert Bosch GmbH	X	X
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.		X

Name	Employer	Affiliation	Open	Close
Houck, TJ	Infineon Technologies	Infineon Technologies		X
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Huber, Thomas	Nokia	Nokia	X	X
Hutchison, Guy	Aviva Links	Aviva Links Inc; Aviva Links Inc.	X	
Hutchison, Guy	Aviva Links	NXP Semiconductors		X
HYAKUTAKE, YASUHIRO	Orbray Co., Ltd.	Orbray Co., Ltd.	X	X
Irwin, Scott	MoSys, Inc.	ADTRAN Inc.	X	X
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components	X	X
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd	X	X
Iwasaki, Yutaka	Hirose Electric Co.,Ltd.	Hirose Electric Co., Ltd.	X	
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	X	X
Jeffreis, Brad		Analog Devices Inc.	X	X
Jin, Robert	Montage Technology, Inc	Montage Technology	X	
Jochim, Markus	General Motors Company	General Motors Company	X	X
Johnson, John	Broadcom Corporation	Broadcom Corporation	X	X
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Jonsson, Ragnar	Marvell Semiconductor, Inc.	Marvell	X	X
Joseph, Gloria		Acsia Technologies	X	
Kagami, Manabu	Nagoya Institute of Technology	Nagoya Institute of Technology (NITech)	X	X
Kandarpa, Venkata	NXP Semiconductors	NXP Semiconductors	X	X
Kapoor, Samay	Aviva Links	Aviva Links Inc.	X	X
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
KATO, TAKAHIRO	Dexerials	Dexerials	X	
Kim, DoKyun	LG ELECTRONICS	LG ELECTRONICS	X	X
Kim, Gyudong	Analog Devices Inc.	Analog Devices Inc.	X	X
Kim, Yongbum	General Motors Company	General Motors Company	X	X
Kimber, Eric	Semtech Ltd	Semtech Ltd	X	X
Kleinwaechter, Mathias	in-tech GmbH	in-tech GmbH	X	X
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Kock, Joerg	NXP Semiconductors	NXP Semiconductors	X	X
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation	X	
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation	X	
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	X	X
Kotani, Yasuhiro	DENSO	DENSO		X

Name	Employer	Affiliation	Open	Close
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell		X
Lackner, Hans	QoSCom GmbH	QoSCom GmbH	X	X
Landry, Gary	Coherent Corp.	Coherent	X	X
Lasry, Ariel	Qualcomm Technologies, Inc	Qualcomm Technologies, Inc	X	X
Law, Andrew	Student	Self		X
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	X	X
Lee, Ching-Yen		Realtek Semiconductor Corp.	X	X
Lee, Dongjae		Newracom Inc.		X
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.	X	X
Lessard, Stephane	Ericsson AB	Ericsson AB		X
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM	X	X
Lewis, Jon	Dell Technologies	Dell Technologies	X	
Li, Jing	YOFC	YOFC	X	
Li, Mike-Peng	Altera Corporation	Intel Corporation	X	X
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.	X	X
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	X	X
Lim, Hoei	NXP Semiconductors	NXP Semiconductors	X	X
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Lin, YK	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	X	X
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.	X	X
Liu, Cathy	Broadcom Corporation	Broadcom Corporation	X	X
Lo, William	Axonne Inc.	Axonne Inc.	X	
Long, Richard	TE Connectivity	TE Connectivity	X	X
Lou, David		Huawei Technologies Duesseldorf GmbH		X
Lou, Wei		Broadcom Corporation	X	
lu, chao	BMW Group	BMW Group	X	X
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.	X	X
Lyu, Yunping(Lily)	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	
Maguire, Valerie	Copperopolis	Copperopolis (aff'l with CME Consulting, Cisco, Dell, Microchip, and NXP)	X	
Maguire, Valerie	Copperopolis	Copperopolis (aff'l with CME Consulting, Cisco, Microchip, and NXP)		X
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise	X	X
Maniloff, Eric	Ciena Corporation	Ciena Corporation	X	X
Marques, Flavio	Lightera	Lightera	X	X
Mascitto, Marco	Nokia Canada Inc.	Nokia	X	X
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH	X	X

Name	Employer	Affiliation	Open	Close
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Mecklenburg, Ben		Huawei Technologies Duesseldorf GmbH	X	X
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	X	
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Miskho, Michael		Analog Devices Inc.	X	X
Moorwood, Charles	Keysight Technologies	Keysight Technologies	X	X
Muller, Shimon	Enfabrica Corp.	Enfabrica	X	X
Muma, Scott	Microchip Technology, Inc.	Microchip Technology, Inc.	X	X
MURAKAMI, YUKI	IFinity	IFinity	X	X
Murray, Brian	Analog Devices Inc.	Analog Devices Inc.	X	X
Murty, Ramana	Broadcom Inc.	Broadcom Corporation	X	X
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation	X	X
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)	X	X
NIIHARA, YOSHIHIRO	Fujikura Ltd.	Fujikura Ltd.	X	X
Ninomiya, Tiger	Accelink USA Corporation	Accelink USA Corporation	X	
Ninomiya, Tiger	Accelink USA Corporation	Accelink / Self		X
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Nowroozi, Bijan	Lightmatter	Lightmatter		X
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	X	X
Oishi, Eiichiro		Yazaki Corporation	X	X
Omori, Kumi	NEC Corporation	NEC Corporation	X	X
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.	X	X
Osorio, Luz	Nokia Canada Inc.	Nokia	X	X
Pal, Debajyoti		ON Semiconductor	X	X
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.	X	X
Pan, Chunpo		Broadcom Corporation	X	X
Park, Pusik		Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI)	X	X
Parkholm, Ulf	Telefon AB LM Ericsson	Ericsson AB	X	X
Parsons, Earl	CommScope Amphenol	CommScope, Inc.	X	X

Name	Employer	Affiliation	Open	Close
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation	X	
Pepper, Gerald	Keysight Technologies	Keysight Technologies	X	X
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.	X	X
Potterf, Jason	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Rabinovich, Rick	Keysight Technologies	Keysight Technologies	X	X
Rajagopal, Karthik	Texas Instruments Inc.	Texas Instruments Inc.	X	X
Ran, Adece	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Ransford, Michael		Corning Incorporated	X	X
Razavi, Alireza	Marvell	Infineon Technologies	X	
Razavi, Alireza	Marvell	Eliyan		X
Reinhard, Michael	SEI Automotive Europe GmbH	SEI Automotive Europe GmbH	X	X
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Rodes, Roberto	II-VI	II-VI	X	X
Rysin, Alexander	NVIDIA	NVIDIA	X	
Sakai, Toshiaki	Socionext Inc.	socionext	X	X
Salata, Carlo		Canova Tech	X	X
Sambasivan, Sam	AT&T	AT&T		X
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated	X	X
Schedl, Anton	BMW Group	BMW Group	X	
Schreiner, Stephan	Rosenberger Hochfrequenztechnik GmbH & Co. KG	Rosenberger	X	X
Sedarat, Hossein	Ethernovia	Ethernovia	X	X
Shah, Anup	Siemens Corporation	Siemens EDA	X	X
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd	X	X
Sharon, Ari		Terawand	X	
Shiino, Masato	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC	X	X
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.	X	X
Shrikhande, Kapil	Marvell Semiconductor, Inc.	Upscale AI	X	X
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.	X	X
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise	X	X
Simms, William	NVIDIA Corporation	NVIDIA Corporation	X	X
sisk, jason	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)	X	X
Slavick, Jeff	Broadcom Inc	Broadcom Inc	X	X
Sommers, Scott	Molex LLC	Molex Incorporated	X	X
Son, Yung Sung	Optomind Inc	Optomind Inc	X	

Name	Employer	Affiliation	Open	Close
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES	X	X
Srivastava, Atul	NEL-America	NTT Electronics	X	
Stencel, Leonard		TDK Corporation of America	X	X
Strohmeier, Heiko	Robert Bosch GmbH	Robert Bosch GmbH	X	X
Sun, jingcong	Motorcomm Electronic Technology Co	Motorcomm Electronic Technology Co	X	
Sun, Wensheng	Credo Semiconductor	Marvell Semiconductor, Inc.	X	
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor		X
Sun, Yi	Lightera	Lightera	X	X
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia	X	X
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY	X	X
TAKEUCHI, JUNICHI	JAE Electronics, Inc	JAE Electronics, Inc.	X	X
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.		X
Tan, Yuxuan	Motorcomm	Motorcomm	X	
Tanc, Ahmet		NXP Semiconductors; NXP Semiconductors	X	X
Tanz, Simon		BMW AG; BMW Group	X	
Tartaglia, Antonio	Ericsson AB	Ericsson AB	X	X
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	X	X
Theodoras, James	Scintil Photonics	Scintil Photonics	X	X
Thomas, Rajan		Acsia Technologies	X	
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	X	X
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	X	X
Torres, Luisma	Knowledge Development for POF SL	KD	X	X
Tracy, Nathan	TE Connectivity	TE Connectivity	X	X
Tran, Viet	Keysight Technologies	Keysight Technologies	X	
Tu, Mike	Broadcom Corporation	Broadcom Corporation	X	X
Turner, Max	Ethernovia	Ethernovia	X	X
Umar, Ashraf		Molex Incorporated	X	X
Vakilian, Kambiz	Broadcom Corporation	Broadcom Corporation	X	X
van Dyck, Peter	Infineon Technologies	Infineon Technologies	X	X
Vanderlaan, Paul	Panduit Corp.	Panduit Corp.	X	X
Veloso Cauce, Gumersindo	BMW Group	BMW AG; BMW Group	X	X
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation	X	X
Voss, Robert	Panduit	Panduit Corp.	X	X
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)	X	

Name	Employer	Affiliation	Open	Close
Wang, Shun-Sheng	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	X	X
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated	X	X
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Wang, Yutao		Rockwell Automation	X	X
Watanabe, Yojiro	Mitsubishi Electric US, Inc.	Mitsubishi Electric US, Inc.		X
Weaver, James	Arista Networks	Arista Networks	X	X
Wei, Terry		Analog Devices Inc.	X	X
Welch, Brian	Cisco Systems, Inc.	Luxtera		X
Wienckowski, Natalie	IVN Solutions LLC	IVN Solutions LLC; Ethernovia, Bosch	X	X
Wig, Timothy	Samtec, Inc.	Samtec, Inc.	X	X
Wingrove, Michael	Ciena Corporation	Ciena Corporation	X	X
Withey, James	Fluke Corporation	Fluke Corporation	X	X
Wu, Dance	Infineon Technologies	Infineon Technologies	X	X
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	X	X
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
xu, wenxiong	HG Genuine	HGGenuine	X	X
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems	X	X
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Yin, Shuang		Google		X
Zerna, Conrad	Aviva Links Inc	NXP Semiconductors	X	X
ZHANG, KAN		China Mobile (Chengdu) Information and Telecommunication	X	
Zhang, Tingting	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Zhang, Wei		Broadcom Corporation	X	X
ZHU, YUE		Huawei Technologies Co., Ltd	X	X
Zhuang, Shu		Anritsu Company	X	
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X
Zimmerman, George	CME Consulting, Inc.	CME Consulting/Analog Devices, APL Group, Cisco, Infineon, OnSemi, Sony	X	
Zimmerman, George	CME Consulting, Inc.	CME Consulting; Analog Devices; Cisco; Eliyan; Infineon; OnSemi; Sony		X

Name	Employer	Affiliation	Open	Close
Zivny, Pavel	Lumilens	Lumilens		X
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	X	X